



8410

Product Information



60µm amber reactive HAF mounting tape

Product Description

tesa® HAF 8410 is a heat activated double-sided amber adhesive film based on reactive phenolic resin and nitrile rubber.

Special Features:

- *Reliable chip module bonding
- *Suitable for PVC, ABS, PET, and PC cards
- *Good workability on all common implanting lines
- *Outstanding ageing resistance
- *Lifelong flexibility due to high rubber content

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Application Fields

tesa® HAF 8410 is especially designed for the embedding of chip-modules into smart cards. It is also suitable for bonding of all thermal resistant materials such as metal, glass, plastic, wood and textiles (e.g. friction liners for clutches).

Technical Information (average values)

The values in this section should be considered representative or typical only and should not be used for specification purposes.

Product Construction

- | | | | |
|--------------------|------------------------------------|-------------------|-------|
| • Backing | none | • Total thickness | 60 µm |
| • Type of adhesive | nitrile rubber /
phenolic resin | • Color | amber |
| • Type of liner | glassine | | |

Properties/Performance Values

- | | |
|------------------------------------|----------------------|
| • Bonding strength (dynamic shear) | 12 N/mm ² |
|------------------------------------|----------------------|

Additional Information

Technical Recommendations for smart card applications:

For latest information on this product please visit <http://l.tesa.com/?ip=08410>

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The following values are recommendations for machine parameters to start with. Please note that optimum parameters strongly depend on the type of machine, particular materials for card bodies and chip-modules as well as customer requirements.

1. Pre-lamination:

During pre-lamination, the adhesive tape is laminated onto the module belt. The pre-lamination step does not effect the shelf life time of the adhesive tape. Pre-laminated module belts can be stored over the same period of time as the adhesive tape.

Machine setting:

- Temperature 120 – 140 °C
- Pressure 2 – 3 bar
- Time 1.5 – 2.5 m/min.

2. Module Embedding:

During module embedding, the pre-laminated modules are die cut from the module belt, positioned into the card cavity and permanently bonded to the card body by heat and pressure. Depending on the type of implanting line, single step or multiple step process can be used. Today, most implanting machines have multiple heat press steps.

Single step process - Machine setting:

- Temperature¹ 180 – 220 °C
- Pressure 65 N/module
- Time 1.5 s.

Multiple step process (2 or more heating stamps) - Machine setting:

- Temperature¹ 180 – 220 °C
- Pressure 65 N/module
- Time 2 x 0,7 s. / 3 x 0.5 s

¹ Temperature as measured inside the heating stamp. Different temperature settings are recommended for different card material:

PVC 180 – 190 °C

ABS 180 – 190 °C

PET 190 – 200 °C

PC 200 – 220 °C

Bonding strength values were obtained under standard laboratory conditions. Value is guaranteed clearance limit checked with each production batch (Material: Etched aluminium test specimen / Bonding conditions: Temp. = 120 °C; p = 10 bar; t = 8 min)

To reach maximum bonding strength surfaces should be clean and dry. Storage conditions according to tesa® HAF shelf life concept.



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